

# For Muting (20V, 0.3A)

## 2SD2704K / 2SD2705S

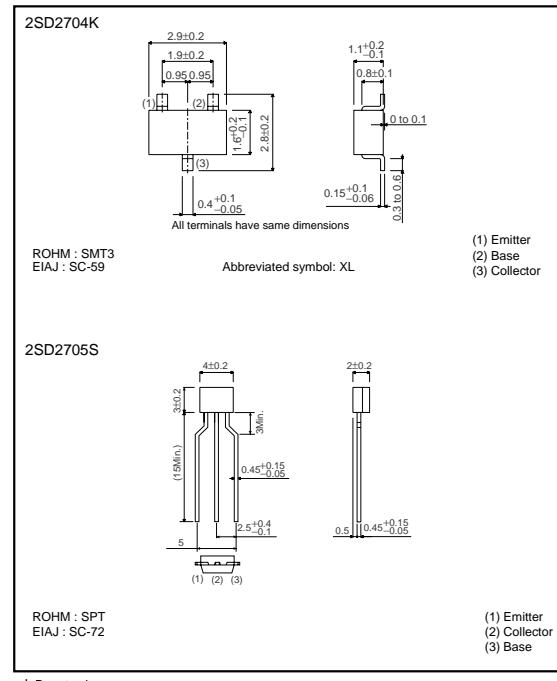
### ●Features

- 1) High DC current gain.  
 $h_{FE} = 820$  to 2700
- 2) High emitter-base voltage.  
 $V_{EBO} = 25V$  (Min.)
- 3) Low  $R_{on}$   
 $R_{on} = 0.7\Omega$  (Typ.)

### ●Structure

Epitaxial planar type  
NPN silicon transistor

### ●External dimensions (Unit : mm)



### ●Absolute maximum ratings ( $T_a=25^\circ C$ )

Parameter	Symbol	Limits	Unit
Collector-base voltage	$V_{CBO}$	50	V
Collector-emitter voltage	$V_{CEO}$	20	V
Emitter-base voltage	$V_{EBO}$	25	V
Collector current	$I_C$	0.3	A
Collector power dissipation	$P_C$	0.2	W
2SD2705S	2SD2705S	0.3	
Junction temperature	$T_J$	150	°C
Storage temperature	$T_{STG}$	-55 to +150	°C

## Transistors

● Electrical characteristics ( $T_a=25^\circ\text{C}$ )

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	$\text{BV}_{\text{CBO}}$	50	—	—	V	$I_c=10\mu\text{A}$
Collector-emitter breakdown voltage	$\text{BV}_{\text{CEO}}$	20	—	—	V	$I_c=1\text{mA}$
Emitter-base breakdown voltage	$\text{BV}_{\text{EBO}}$	25	—	—	V	$I_e=10\mu\text{A}$
Collector cutoff current	$I_{\text{CBO}}$	—	—	0.1	$\mu\text{A}$	$V_{\text{CB}}=50\text{V}$
Emitter cutoff current	$I_{\text{EBO}}$	—	—	0.1	$\mu\text{A}$	$V_{\text{EB}}=25\text{V}$
Collector-emitter saturation voltage	$V_{\text{CE}(\text{sat})}$	—	50	100	mV	$I_c/I_b=30\text{mA}/3\text{mA}$
DC current transfer ratio	$h_{\text{FE}}$	820	—	2700	—	$V_{\text{CE}}=2\text{V}, I_c=4\text{mA}$
Transition frequency	$f_T^*$	—	35	—	MHz	$V_{\text{CE}}=6\text{V}, I_e=-4\text{mA}, f=10\text{MHz}$
Output capacitance	$C_{\text{OB}}$	—	3.9	—	pF	$V_{\text{CB}}=10\text{V}, I_e=0\text{A}, f=1\text{MHz}$
Output On-resistance	$R_{\text{ON}}$	—	0.7	—	$\Omega$	$I_b=5\text{mA}, V_i=100\text{mV(rms)}, f=1\text{kHz}$

\* Measured using pulse current

● Packaging specifications and  $h_{\text{FE}}$ 

Type	Package	Taping	
		T146	TP
	Basic ordering unit (pieces)	3000	5000
2SD2704K		○	—
2SD2705S		—	○

## ● Electrical characteristic curves

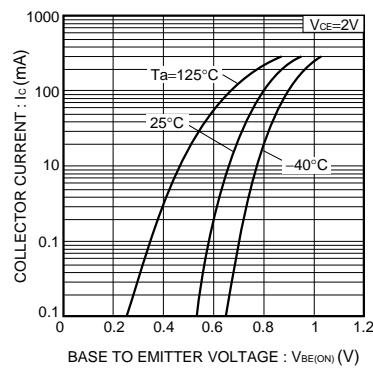


Fig.1 Grounded emitter propagation characteristics ( I )

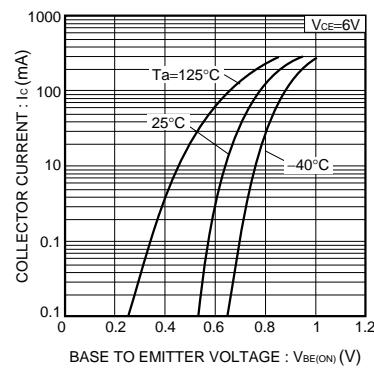


Fig.2 Grounded emitter propagation characteristics ( II )

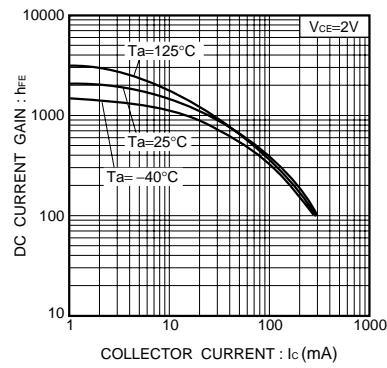


Fig.3 DC current gain vs. collector current ( I )

## Transistors

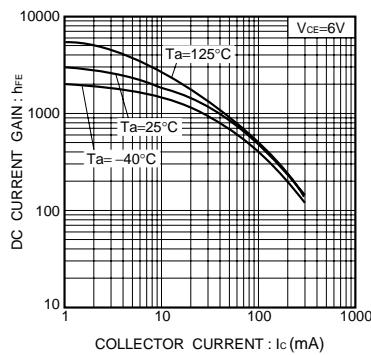


Fig.4 DC current gain  
vs. collector current (II)

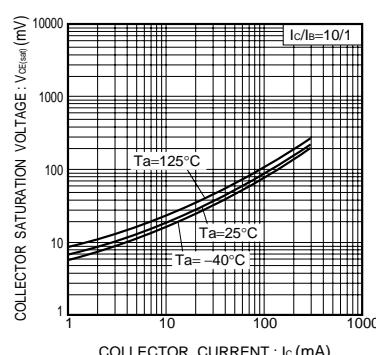


Fig.5 Collector-emitter saturation voltage  
vs. collector current (I)

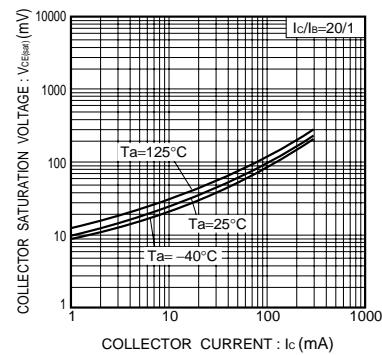


Fig.6 Collector-emitter saturation voltage  
vs. collector current (II)

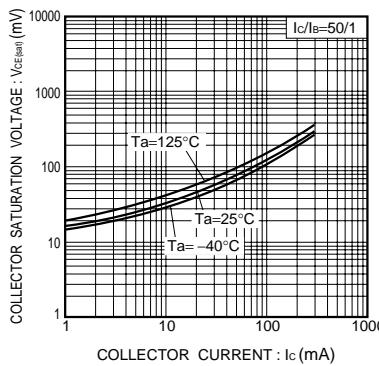


Fig.7 Collector-emitter saturation voltage  
vs. collector current (III)

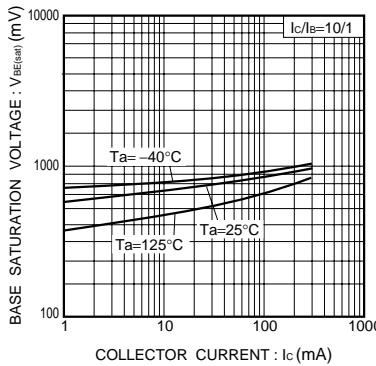


Fig.8 Base-emitter saturation voltage  
vs. collector current (I)

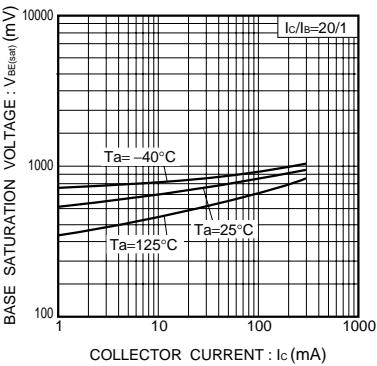


Fig.9 Base-emitter saturation voltage  
vs. collector current (II)

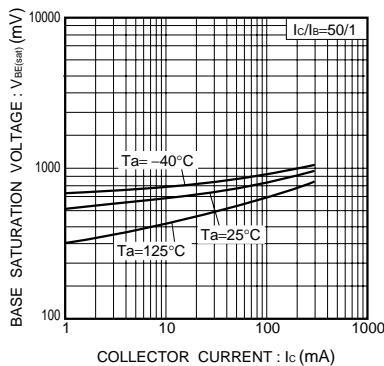


Fig.10 Base-emitter saturation voltage  
vs. collector current (III)

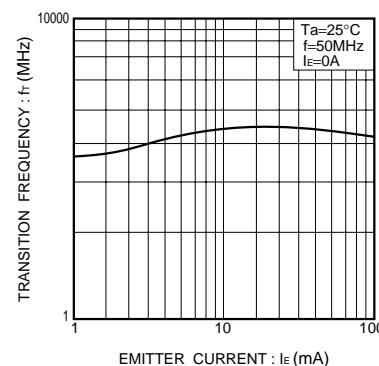


Fig.11 Gain bandwidth product  
vs. emitter current

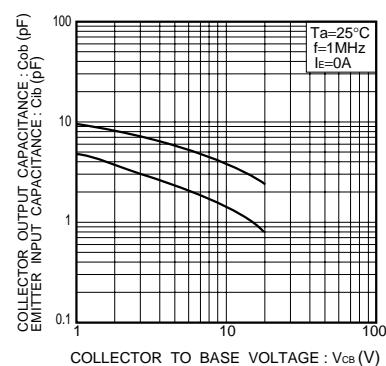


Fig.12 Collector output capacitance  
vs. collector-base voltage  
Emitter input capacitance  
vs. emitter-base voltage

## Transistors

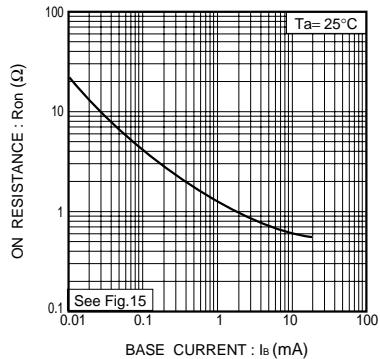


Fig.13 Output-on resistance vs. base current ( I )

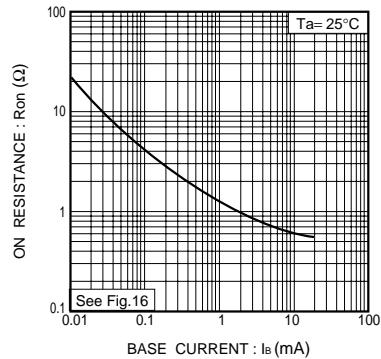


Fig.14 Output-on resistance vs. base current ( II )

## ●Ron measurement circuit

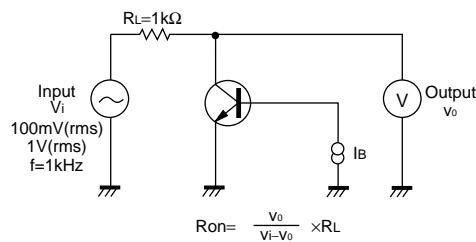


Fig.15 Ron measurement circuit ( I )

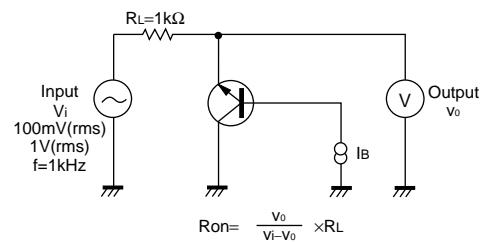


Fig.16 Ron measurement circuit ( II )

## Appendix

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